

## PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1  
 Stylesheet Version v1.2

EPAS ID: PAT6580044

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
IGOR ELKANOVICH	12/17/2020
YEN-CHUNG T. CHEN	12/13/2020
CHIA-HSIANG CHANG	12/24/2020
TING-HSU CHIEN	12/20/2020
TSAI-MING YANG	12/24/2020
WEI-AN LIANG	12/24/2020
AMNON PARNASS	12/22/2020
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	GLOBAL UNICHIP CORPORATION
<b>Street Address:</b>	NO.10, LIXING 6TH RD., SCIENCE-BASED INDUSTRIAL PARK,
<b>City:</b>	HSINCHU
<b>State/Country:</b>	TAIWAN
<b>Postal Code:</b>	30078
<b>Name:</b>	TAIWAN SEMICONDUCTOR MANUFACTURING COMPANY, LTD.
<b>Street Address:</b>	NO.8, LI-HSIN RD. 6, HSINCHU SCIENCE PARK,
<b>City:</b>	HSINCHU
<b>State/Country:</b>	TAIWAN
<b>Postal Code:</b>	300-78
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
<b>Application Number:</b>	17185895
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	(949)391-4699
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<b>Phone:</b>	886223692800
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<b>Address Line 1:</b>	8F-1, NO. 100, ROOSEVELT RD. SEC. 2,
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PATENT

<b>ATTORNEY DOCKET NUMBER:</b>	105583-US-PA
<b>NAME OF SUBMITTER:</b>	BELINDA LEE
<b>SIGNATURE:</b>	/Belinda Lee/
<b>DATE SIGNED:</b>	03/02/2021
<b>Total Attachments: 9</b> source=105583_del-assn#page1.tif source=105583_del-assn#page2.tif source=105583_del-assn#page3.tif source=105583_del-assn#page4.tif source=105583_del-assn#page5.tif source=105583_del-assn#page6.tif source=105583_del-assn#page7.tif source=105583_del-assn#page8.tif source=105583_del-assn#page9.tif	

**DECLARATION AND ASSIGNMENT  
FOR UTILITY OR DESIGN PATENT APPLICATION**

☒ Declaration Submitted With Initial Filing

OR

☐ Declaration Submitted After Initial Filing (surcharge 37 CFR 1.16(f) required)

(Title of the Invention)

**CIRCUIT OF COMMUNICATION INTERFACE BETWEEN TWO DIES AND  
METHOD TO MANAGE COMMUNICATION INTERFACE**

As a below named inventor (hereinafter designated as the undersigned), I hereby  
declare that:

This declaration is directed to:

☒ The attached application,

OR

☐ United States Application Number or PCT International application number

\_\_\_\_\_ Filed on \_\_\_\_\_

The above-identified application was made or authorized to be made by me.

I believe I am the original inventor or an original joint inventor of a claimed invention in  
the application.

The undersigned hereby acknowledge that any willful false statement made in this  
declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more  
than five (5) years, or both.

**DECLARATION AND ASSIGNMENT  
FOR UTILITY OR DESIGN PATENT APPLICATION**

WHEREAS, the undersigned has invented certain new and useful improvements described in the application identified.

**WHEREAS,** 1. Global Unichip Corporation  
of No.10, Lixing 6th Rd., Science-Based Industrial Park, Hsinchu 30078,  
Taiwan (R.O.C.)  
, 2. Taiwan Semiconductor Manufacturing Company, Ltd.  
of No.8, Li-Hsin Rd. 6, Hsinchu Science Park, Hsinchu, Taiwan 300-78,  
R.O.C.

hereinafter referred to as ASSIGNEE, is desirous of acquiring the undersigned's interest in the said invention and application and in any U.S. Letters Patent which may be granted on the same:

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for good and valuable consideration, receipt of which is hereby acknowledged by the undersigned, the undersigned has/have sold, assigned and transferred, and by these presents does/do sell, assign and transfer unto the said Assignee, and Assignee's successors and assigns, all his/her/their rights, title and interest in and to the said invention and application and all future improvements thereon, and in and to any Letters Patent which may hereafter be granted on the same in the United States, the said rights, title and interest to be held and enjoyed by said Assignee as fully and exclusively as it would have been held and enjoyed by said the undersigned had this Assignment and transfer not been made, to the full end and term of any Letters Patent which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof.

The undersigned further agrees/agree that he/she/they will, without charge to said Assignee, but at Assignee's expense, cooperate with Assignee in the prosecution of said application and/or applications, execute, verify, acknowledge and deliver all such further papers, including applications for Letters Patent and for the reissue thereof, and instruments of assignment and transfer thereof, and will perform such other acts as Assignee Lawfully may request, to obtain or maintain Letters Patent for said invention and improvement, and to vest title thereto in said Assignee, or Assignee's successors and assigns.

**DECLARATION AND ASSIGNMENT  
FOR UTILITY OR DESIGN PATENT APPLICATION**

Signature: *Igor E Elkanovich* Date: 17/Dec/2020

Legal Name of Sole or First Inventor: **Igor Elkanovich**

**17 DEC 2020**

Residence: Hsinchu, Taiwan

Mailing Address: c/o No.10, Lixing 6th Rd., Science-Based Industrial Park, Hsinchu 30078, Taiwan  
(R.O.C.)

Signature: \_\_\_\_\_ Date: \_\_\_\_\_

Legal Name of Additional Joint Inventor, if any: **Yen-Chung T. Chen**

Residence: Santa Clara, CA, USA

Mailing Address: c/o No.10, Lixing 6th Rd., Science-Based Industrial Park, Hsinchu 30078, Taiwan  
(R.O.C.)

Signature: \_\_\_\_\_ Date: \_\_\_\_\_

Legal Name of Additional Joint Inventor, if any: **Chia-Hsiang Chang**

Residence: Hsinchu, Taiwan

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(R.O.C.)

Signature: \_\_\_\_\_ Date: \_\_\_\_\_

Legal Name of Additional Joint Inventor, if any: **Ting-Hsu Chien**

Residence: Hsinchu County, Taiwan

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**DECLARATION AND ASSIGNMENT  
FOR UTILITY OR DESIGN PATENT APPLICATION**

Signature: \_\_\_\_\_ Date: \_\_\_\_\_

Legal Name of Sole or First Inventor: **Igor Elkanovich**

Residence: Hsinchu, Taiwan

Mailing Address: c/o No.10, Lixing 6th Rd., Science-Based Industrial Park, Hsinchu 30078, Taiwan  
(R.O.C.)

Signature: Yen-Chung T. Chen Date: 12/13/2020

Legal Name of Additional Joint Inventor, if any: **Yen-Chung T. Chen** **13 DEC 2020**

Residence: Santa Clara, CA, USA

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Signature: \_\_\_\_\_ Date: \_\_\_\_\_

Legal Name of Additional Joint Inventor, if any: **Chia-Hsiang Chang**

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Signature: \_\_\_\_\_ Date: \_\_\_\_\_

Legal Name of Additional Joint Inventor, if any: **Ting-Hsu Chien**

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2020-020US  
105583-US-PA

**DECLARATION AND ASSIGNMENT  
FOR UTILITY OR DESIGN PATENT APPLICATION**

Signature: \_\_\_\_\_ Date: \_\_\_\_\_

Legal Name of Sole or First Inventor: **Igor Elkanovich**

Residence: Hsinchu, Taiwan

Mailing Address: c/o No.10, Lixing 6th Rd., Science-Based Industrial Park, Hsinchu 30078, Taiwan  
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Signature: \_\_\_\_\_ Date: \_\_\_\_\_

Legal Name of Additional Joint Inventor, if any: **Yen-Chung T. Chen**

Residence: Santa Clara, CA, USA

Mailing Address: c/o No.10, Lixing 6th Rd., Science-Based Industrial Park, Hsinchu 30078, Taiwan  
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Signature: *Chia-Hsiang Chang* Date: *2020.12.24*

Legal Name of Additional Joint Inventor, if any: **Chia-Hsiang Chang**

Residence: Hsinchu, Taiwan

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(R.O.C.)

Signature: \_\_\_\_\_ Date: \_\_\_\_\_

Legal Name of Additional Joint Inventor, if any: **Ting-Hsu Chien**

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Mailing Address: 8F., No.77, Chenggong 1st St., Zhubei City, Hsinchu County 302, Taiwan (R.O.C.)

**DECLARATION AND ASSIGNMENT  
FOR UTILITY OR DESIGN PATENT APPLICATION**

Signature: \_\_\_\_\_ Date: \_\_\_\_\_

Legal Name of Sole or First Inventor: **Igor Elkanovich**

Residence: Hsinchu, Taiwan

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Signature: \_\_\_\_\_ Date: \_\_\_\_\_

Legal Name of Additional Joint Inventor, if any: **Yen-Chung T. Chen**

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Signature: \_\_\_\_\_ Date: \_\_\_\_\_

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Signature: **Ting-Hsu Chien** Date: **2020.12.20**

Legal Name of Additional Joint Inventor, if any: **Ting-Hsu Chien**

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**DECLARATION AND ASSIGNMENT  
FOR UTILITY OR DESIGN PATENT APPLICATION**

Signature: Tsai Ming Yang Date: 12/24/2020

Legal Name of Additional Joint Inventor, if any: **Tsai-Ming Yang**

Residence: Hsinchu, Taiwan

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(R.O.C.)

Signature: \_\_\_\_\_ Date: \_\_\_\_\_

Legal Name of Additional Joint Inventor, if any: **Wei-An Liang**

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Signature: \_\_\_\_\_ Date: \_\_\_\_\_

Legal Name of Additional Joint Inventor, if any: **Amnon Parnass**

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2020-020US  
105583-US-PA

**DECLARATION AND ASSIGNMENT  
FOR UTILITY OR DESIGN PATENT APPLICATION**

Signature: \_\_\_\_\_ Date: \_\_\_\_\_

Legal Name of Additional Joint Inventor, if any: **Tsai-Ming Yang**

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DEC 24 2020

Signature: WEI-An Liang Date: 12/24

Legal Name of Additional Joint Inventor, if any: **Wei-An Liang**

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Signature: \_\_\_\_\_ Date: \_\_\_\_\_

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**DECLARATION AND ASSIGNMENT  
FOR UTILITY OR DESIGN PATENT APPLICATION**

Signature: \_\_\_\_\_ Date: \_\_\_\_\_

Legal Name of Additional Joint Inventor, if any: **Tsat-Ming Yang**

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(R.O.C.)

Signature: \_\_\_\_\_ Date: \_\_\_\_\_

Legal Name of Additional Joint Inventor, if any: **Wei-An Liang**

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Signature: \_\_\_\_\_  Date: 22/Dec/2020

Legal Name of Additional Joint Inventor, if any: **Amnon Parnass**

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